

High Fidelity Stereo SPDT Switch with Pop and Click Elimination

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Features

- Single supply range operating from 3.0V to 4.5V
- -118dB THD+N into 100kΩ load at 2Vrms
- -114dB THD+N into 32Ω load at 2Vrms
- Signal-to-Noise (SNR) Ratio 132dBA
- 100dB PSRR at 10kHz
- 145dB crosstalk & separation
- Pop/Click shunt circuit
- Audio Path Soft Turn-On/Off for Pop & Click Elimination
- operates over an ambient temperature range of -40 °C to +85 °C
- Packaging: WLCSP 1.2 x 1.2 -9 Ball

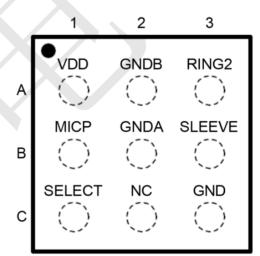
Applications

- Mobile Phones/Tablet PCs
- Notebook/Ultrabook Computers

General Description

The is an audio headset analog switch that is used to detect 3.5mm accessories and switch sleeve and ring by external controller. The ground signal is routed through a pair of low-impedance ground FETs ($75m\Omega$ typical), resulting minimal impact on audio cross-talk performance. The ground FETs of the device are designed to allow FM signal pass-through, making it possible to use the ground line of the headset as an FM antenna in mobile audio application.

PIN CONFIGURATIONS (TOP VIEW)



PIN DESCRIPTION

PIN	NAME	FUNCTION
A1	VDD	Power Supply for the Chip.
A2	GNDB	FET2 Ground Reference.
A3	RING2	Connected to the RING2 Segment of the Jack. This pin will be routed to MICP or GNDB depending on the logic level of SELECT pin.
B1	MICP	Microphone Signal Connection to Codec. Microphone bias should be fed into this pin.
B2	GNDA	FET1 Ground Reference.
ВЗ	SLEEVE	Connected to the SLEEVE Segment of the Jack. This pin will be routed to MICP or GNDA depending on the logic level of SELECT pin.
C1	SELECT	The Logic Signal Used to Control S1 Switch, FET1 and FET2.
C2	NC	No Connection.
C3	GND	Chip Ground Reference.

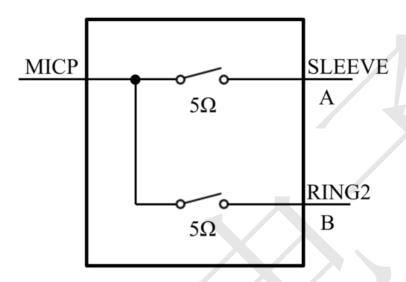




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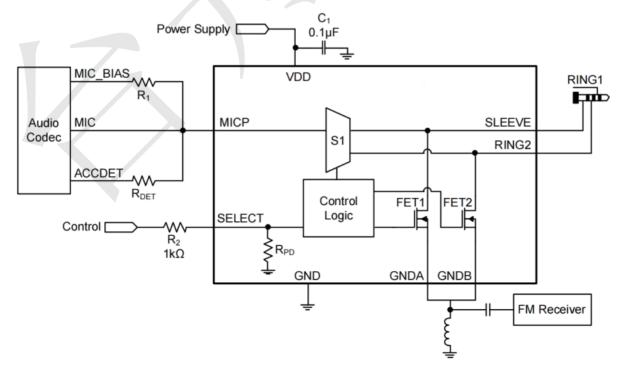
Functional Diagram



Truth Table

	SELECT	FUNCTION		
	0	MICP = A = SLEEVE, FET2 Turn On, FET1 Turn Off.		
1 MICP = B = RING2, FET2 Turn Off, FET1 Turn On.		MICP = B = RING2, FET2 Turn Off, FET1 Turn On.		

Typical Application





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Absolute Maximum Ratings

Parameter	Symbol	Value	Unit	
Supply Voltage	Vcc	-0.3 ~6	V	
Voltage Range on SELECT, MICP, RING2,	V _{IS}	-0.3 ~	V	
SLEEVE	Vis	VDD+0.3V	V	
Storage Temperature Range	T _{STG}	-55 ~ 150	°C	
Junction Temperature	T _J	150	°C	
Lead Temperature (Soldering, 10 seconds)	Tι	260	°C	
Thermal Resistance	R _{0JA}	80	°C/W	

Note:

Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied

Recommend operating ratings

Parameter	Symbol	Value	Unit
Supply Voltage	Vcc	2.6 ~ 5.0	V
Input/Output Voltage Range	V _{IN}	0.0 ~ 3.3	V
operates over an ambient temperature range	TA	-40°C to +85	$^{\circ}$

Note:

The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.



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DC Electrical Characteristics

(V_{DD} = 2.6V to 5.0V, typical values are at V_{DD} = 3.3V, T_A = +25 °C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
Input Voltage Range	VDD		2.6		5.0	V	
Quiescent Current	IQ	VDD = 4.5V, VMICP = 1.8V to VDD, SELECT = Low or SELECT = High (after detection)		4		μА	
Input/Output Voltage Range	VIO		0		3.3	V	
		VDD = 2.6V	1.1		VDD		
Input Logic High for SELECT	N/m s	V _{DD} = 3.3V	1.1		VDD	V	
	VIH	V _{DD} = 4.5V	1.3		VDD		
		VDD = 2.6V	0		0.7		
Input Logic Low for SELECT	VIL	V _{DD} = 3.3V	0		0.8	V	
		VDD = 4.5V	0		0.8		
Pull Down Resistor of Select Pin	RPD			560		kΩ	
FET1 On Resistance	RF1	V _{DD} = 2.6V, V _{GND} = 0V,		75		mΩ	
FET2 On Resistance	RF2	IGND = 10mA		75		11177	
S1 On Resistance (Closed to A)	RS1A	VDD = 2.6V,		5			
S1 On Resistance (Closed to B)	RS1B	VSLEEVE/RING2 = 0V to 2.6V,IMIC = ±10mA		5	-	Ω	

Note:

- (1) Flatness is defined as the difference between maximum and minimum value of ON-resistance at the specified analog signal voltage points.
- (2) R_{ON} matching between channels is calculated by subtracting the channel with the lowest max Ron value from the channel with the highest max Ron value.

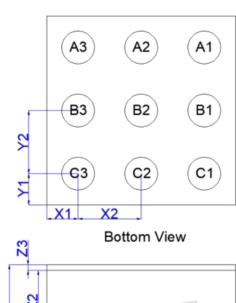


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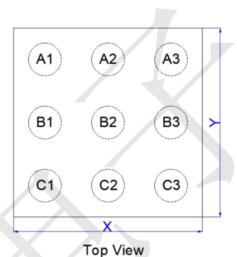
Package informantion

WLCSP-9B(1.2X1.2) (Unit: mm)



.X3

Side View



Symbol	Dimensions In Millimeter				
Symbol	Min.	Тур.	Max.		
X	1.145	1.17	1.195		
Y	1.145	1.17	1.195		
X1		0.185			
X2		0.400			
Х3	0.245	0.270	0.295		
Y1		0.185			
Y2		0.400			
Z	0.535	0.575	0.615		
Z 1	0.170	0.195	0.22		
Z2	0.345	0.355	0.365		
Z3	0.02	0.025	0.03		